GP1A30R

OPIC Photointerrupter with Encoder Function

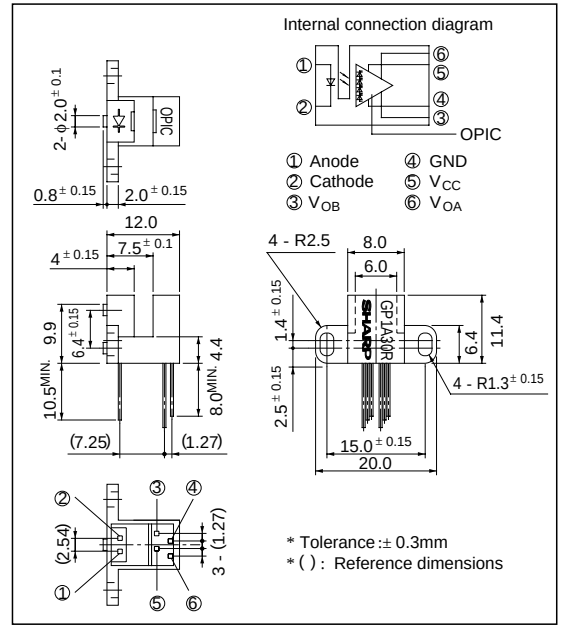
■ Features

1. 2-phase (A, B) digital output
2. Possible to use plastic disk
3. High sensing accuracy
   (Disk slit pitch : 0.7mm)
4. TTL compatible output
5. Compact and light

■ Applications

1. Electronic typewriters, printers
2. Numerical control machines

■ Outline Dimensions (Unit : mm)



*" OPIC" (Optical IC) is a trademark of the SHARP Corporation.
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Absolute Maximum Ratings (Ta= 25˚C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	65	mA
	*1Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	100	mW
Output	Supply voltage	V_{CC}	7	V
	Low level output current	I_{OL}	20	mA
	Power dissipation	P_O	250	mW
Operating temperature		T_{opr}	0 to + 70	˚C
Storage temperature		T_{stg}	- 40 to + 80	˚C
*2Soldering temperature		T_{sol}	260	˚C

*1 Pulse width <= 100μs, Duty ratio= 0.01 *2 For 5 seconds

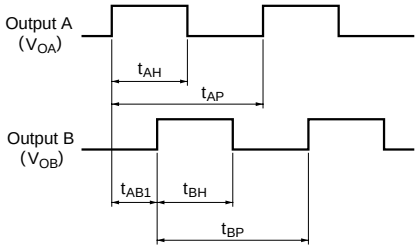
■ Electro-optical Characteristics (Unless otherwise specified, Ta = 0 to + 70˚C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	Ta= 25˚C, I_F= 30mA	-	1.2	1.5	V
	Reverse current	I_R	Ta= 25˚C, V_R= 3V	-	-	10	μA
Output	Operating supply voltage	V_{CC}		4.5	5.0	5.5	V
	High level output voltage	V_{OH}	*3V_{CC}= 5V, I_F= 30mA	2.4	4.9	-	V
	Low level output voltage	V_{OL}	*3I_{OL} = 8mA, V_{CC} = 5V, I_F = 30mA	-	0.1	0.4	V
	Supply current	I_{CC}	*3*4I_F= 30mA, V_{CC}= 5V	-	5	20	mA
Transfer characteristics	Duty ratio	*5D_A	V_{CC}= 5V, I_F= 30mA,	20	50	80	%
		*5D_B	*3f= 2.5kHz	20	50	80	%
	Response frequency	$f_{MAX.}$	*3V_{CC}= 5V, I_F= 30mA	-	-	5	kHz

*3 Measured under the condition shown in Measurement Conditions.
*4 In the condition that output A and B are low level.

*5
$$D_A = \frac{t_{AH}}{t_{AP}} \times 100, \quad D_B = \frac{t_{BH}}{t_{BP}} \times 100$$

■ Output Waveforms



Rotational direction: Counterclockwise when seen from OPIC light detector

Fig. 1 Forward Current vs. Ambient Temperature

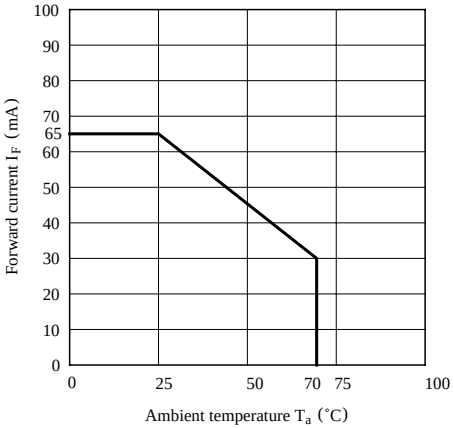


Fig. 2 Output Power Dissipation vs. Ambient Temperature

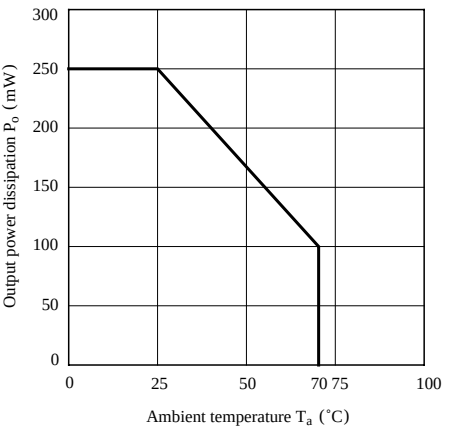


Fig. 3 Duty Ratio vs. Frequency

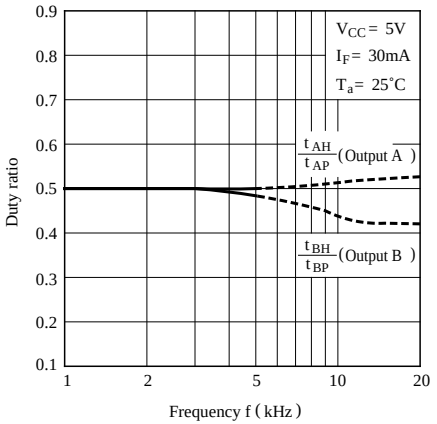


Fig. 4 Phase Difference vs. Frequency

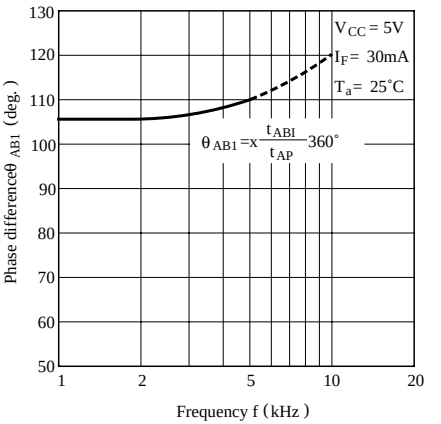


Fig. 5 Duty Ratio vs. Ambient Temperature

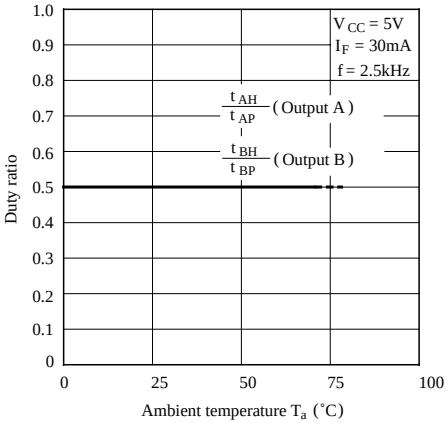


Fig. 6 Phase Difference vs. Ambient Temperature

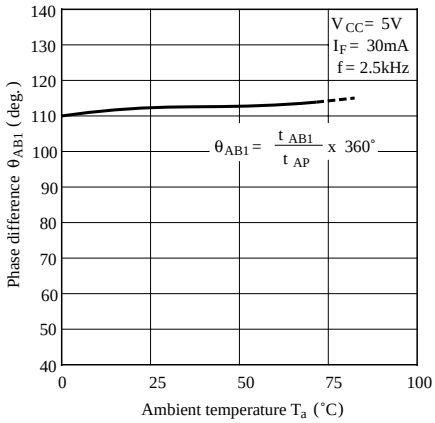


Fig. 7 Duty Ratio vs. Distance (X direction)

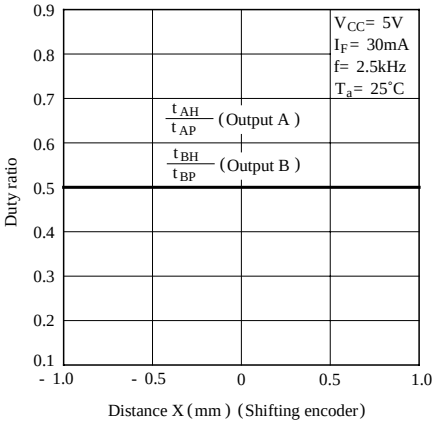


Fig. 8 Phase Difference vs. Distance (X direction)

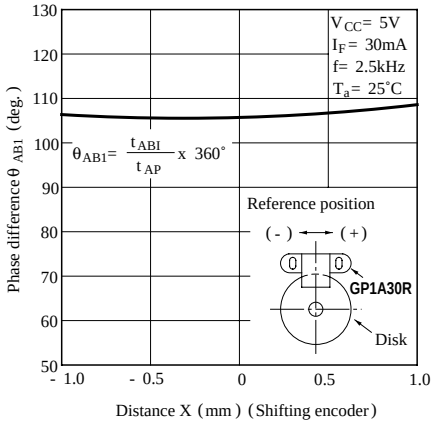


Fig. 9 Duty Ratio vs. Distance (Y direction)

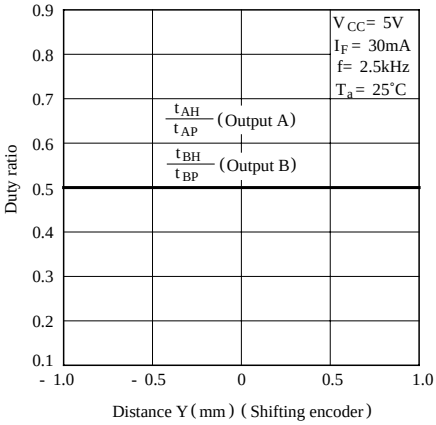


Fig.10 Phase Difference vs. Distance (Y direction)

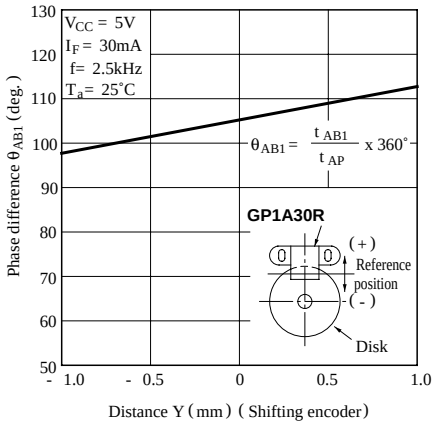


Fig.11 Duty Ratio vs. Distance (Z direction)

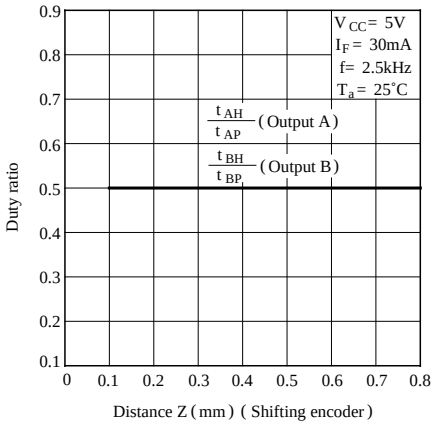
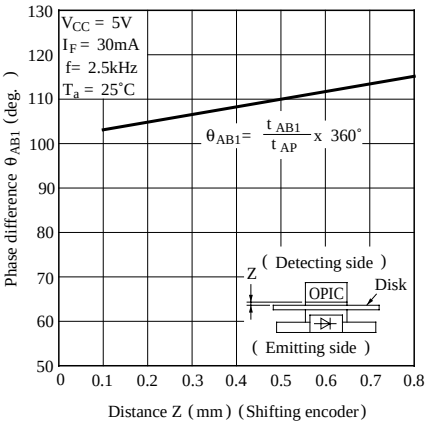
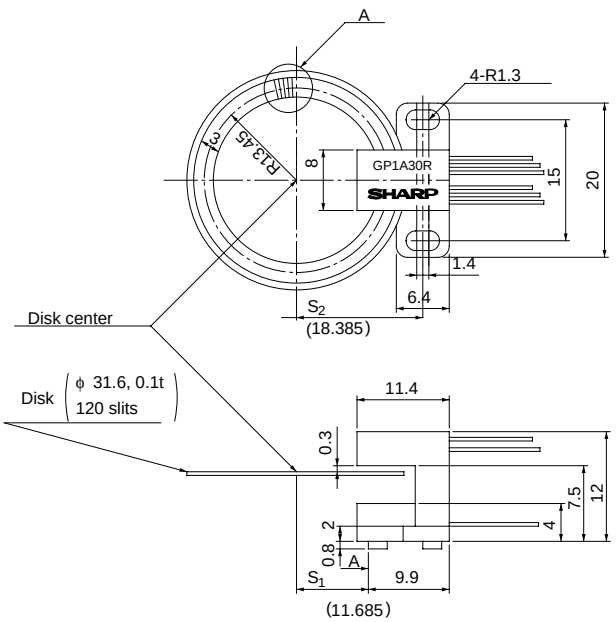


Fig.12 Phase Difference vs. Distance (Z direction)



■ Measurement Conditions



<Basic Design>

R_O (distance between the disk center and half point of a slit), P (slit pitch), S_1 and S_2 (installing position of photointerrupter) will be provided by the following equations.

Slit pitch: P (slit center)

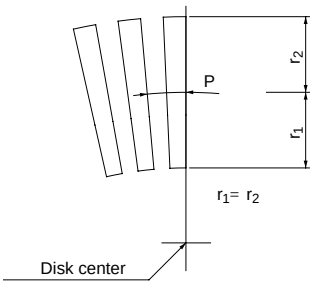
$R_O = \frac{N}{120} \times 13.45$ (mm) N: number of slits

$P = \frac{2 \times p \times R_O}{N}$ (mm)

$S_1 = R_O - 1.765$ (mm), $S_2 = S_1 + 6.7$ (mm)

Note) When the number of slits is changed, values in parenthesis are also changed according to the number.

Enlarged drawing of A portion
Slit pitch : P



(Ex.) In the case of N= 200P/R

$R_O = \frac{200}{120} \times 13.45$ (mm)
= 22.42mm

$P = \frac{2 \times p \times 22.42}{200}$ (mm)
= 0.704mm

S_1= 22.42- 1.765
= 20.655mm

S_2= 20.655+ 6.7
= 27.355mm

■ Precautions for Use

(1) This module is designed to be operated at I_F= 30mA TYP.

(2) Fixing torque: MAX. 0.6Nm (6kgf • cm)

(3) In order to stabilize power supply line, connect a by-pass capacitor of more than 0.01μF between Vcc and GND near the device.

(4) As for other general cautions, refer to the chapter "Precautions for Use".